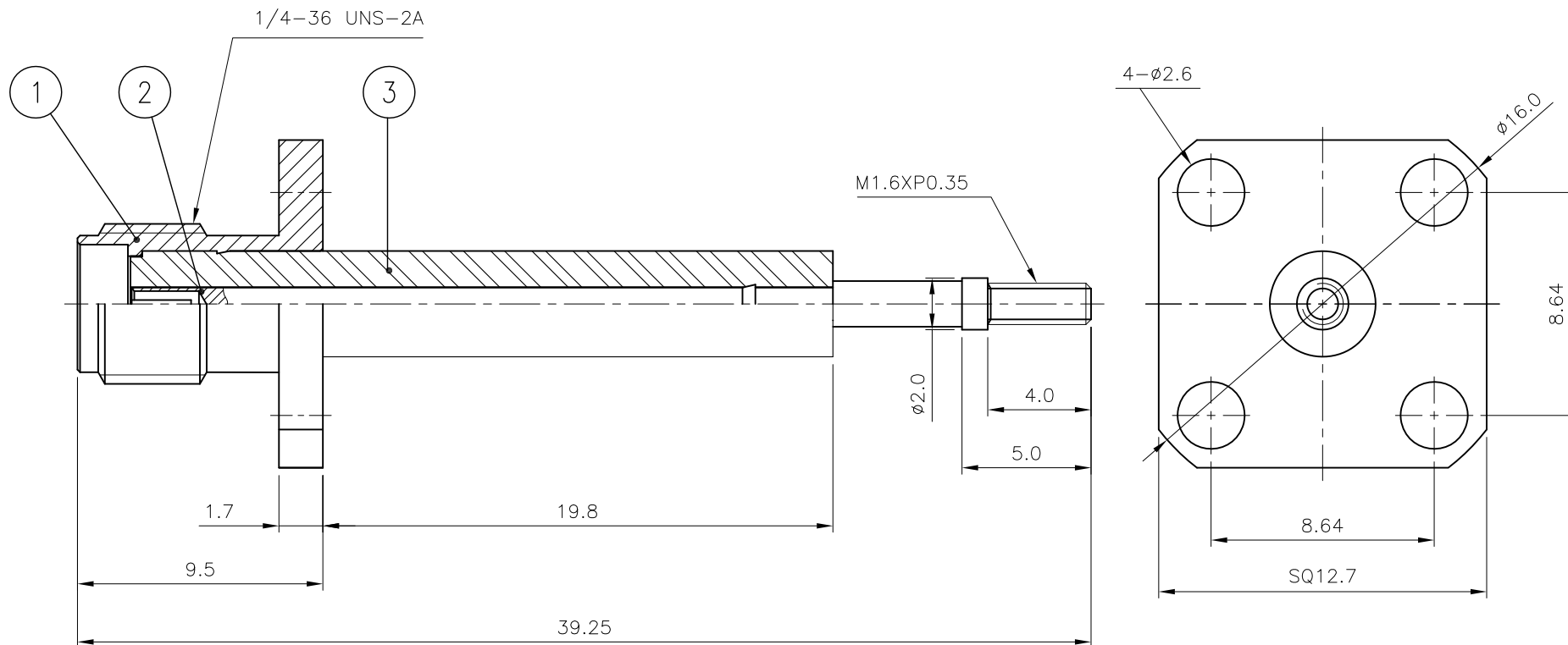


* 부품 상태로 사용함. CONNECTOR 조립 하지 말것.

REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	S.L.SON	J.H.YOUN	2020.03.09.



3	INSULATOR	1	TEFLON		DIN03128-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT04111-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04604-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

조립순서

1. ①번 BODY에 ③번 TEFLON을 조립한다.
2. ②번 PIN 은 ANTENNA HOUSING에 BODY를 결합하고 결합한다.

TOLERANCE	Decimal	DATE 2020. 03. 09.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	J.H.YOUN	
MATERIAL		CHECKED BY		TITLE SMA50 JS-4H
		DRAWN BY	S.L.SON	
FINISH		SCALE	4/1	DWG NO. CN03914-7/1
		UNIT	mm	
				A4
		REVISION	1	SHEET 1 of 1